

RF Components up to 50GHz

GaAs MMIC (available in Die, QFN or SOT)

Power Detector - Up to 40GHz, 1dB flatness and dynamic range of 30dB.

Spiral Inductors – Inductance of 5-200nH with Resonant Frequency starting at 1GHz.

Quartz Substrate Passive Components – up to 50GHz with 3dB, 90° Integrated absorption resistance and insertion loss 0.6-1.2dB.

Power Amplifiers – Up to 40GHz, 34dB Gain and over 43dBm Psat.

Driver Amplifiers - Up to 40GHz, narrow and wideband, up to 24dB Gain.

Gain Block and Distributed Amplifiers – up to 40GHz wideband with P-1db up to 23dBm.

LNA – Up to 40GHz, narrow and wideband, available in Die, QFN or SOT.

Switches – Up to 20GHz, wideband SPDT, SP3T, SP4T and SPST. Isolation up to 70dB and switch speed starting at 5ns.

Digital Attenuator – up to 18GHz, insertion loss starting at -0.7dB, Attenuation up to 31.5dB and VSWR from 1.2.

Digital Phase Shifters - Up to 38GHz, 5-6 Bits, VSWR from 1.2 and phase error from 1.5 deg.

Mixer- Up to 40GHz, narrow and wideband ideal for Up or Down converter, double balanced or IQ mixer applications.

Power Divider – Up to 26GHz, wideband with insertion loss from 0.7dB and isolation up to 35dB.

Equalizer – Up to 20GHz, with Gain delta from 2dB and group delay of up to 5 pS/GHz.

Low Noise FET – Up to 8GHz wideband with 0.5dB NF, P-1 up to 18dBm and OIP3 of 33dB.

Multifunctional Chip

Multifunctional Control Device W/O Amplifier – Up to 12GHz, available in die or QFN.

Multifunctional Mixer – designed per customer requirements.

Bilateral Amplifier – designed per customer requirements.

Microwave Modules (custom units available)

Connectorized Driver Amplifiers – Wideband, up to 40GHz and 46dB Gain.

Connectorized Power Amplifiers – Up to 36GHz and 47.5dBm OIP3.

Connectorized Low Noise Amplifiers – Up to 18GHz, narrow or wideband with Gain up 60dB.

Custom MMICs at frequencies from DC to 50 GHz, includes:

- 1) Product Specifications with the customer
- 2) Physical Layout and Simulation for your approval.
- 3) Electromagnetic Analysis and Thermal Analysis for testing the design efficiency.
- 4) Packaging per customer requirements.
- 5) Measurement, Test and Product Release Support.
- 6) Test Fixture and Application Engineering Support (QA).

For more information - please contact us: